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March 2015

FDD86110

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 50 A, 10.2 m $\Omega$

#### Features

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 10.2 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 12.5 A
- Max  $r_{DS(on)}$  = 16 m $\Omega$  at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 9.8 A
- 100% UIL tested
- RoHS Compliant

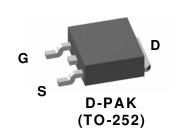


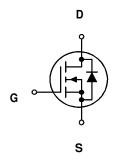
## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

### Application

DC - DC Conversion





### **MOSFET Maximum Ratings** $T_C = 25 \text{ °C}$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C		50	_	
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	12.5	Α	
	-Pulsed		(Note 4)	150		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	135	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		127		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.1		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

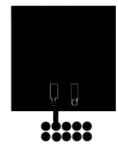
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.98	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	40	0/11

#### Package Marking and Ordering Information

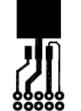
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86110	FDD86110	D-PAK(TO-252)	13 "	16 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics					1	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		72		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2	2.8	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-10		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}$		8.5	10.2		
		$V_{GS} = 6 V, I_D = 9.8 A$	11.		16	mΩ	
		$V_{GS}$ = 10 V, $I_{D}$ = 12.5 A, $T_{J}$ = 125°C		15	18		
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}$		38		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			1702	2265	pF	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, == 1MHz		379	505	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			17	30	pF	
R <sub>g</sub>	Gate Resistance		0.1	0.5	1.5	Ω	
Switching	Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			12	20	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 12.5 A,		5.4	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		19	35	ns	
t <sub>f</sub>	Fall Time			3.9	10	ns	
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{DD} = 50 \text{ V},$		25	35	nC	
Q <sub>gs</sub>	Gate to Source Charge	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 12.5 A		7.1		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.2		nC	
Drain-Sou	Irce Diode Characteristics						
V <sub>SD</sub>	Source-Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12.5 A (Note 2)		0.80	1.3	V	
		$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.72	1.2		
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 12.5 A, di/dt = 100 A/μs		52	83	ns	

Notes: 1:  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design.



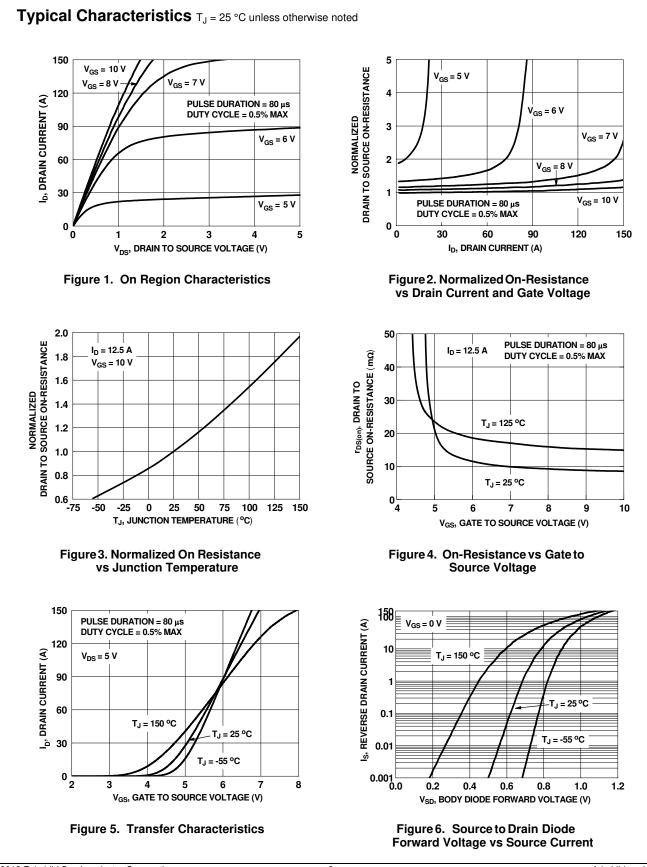
a) 40 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b) 96 °C/W when mounted on a minimum pad

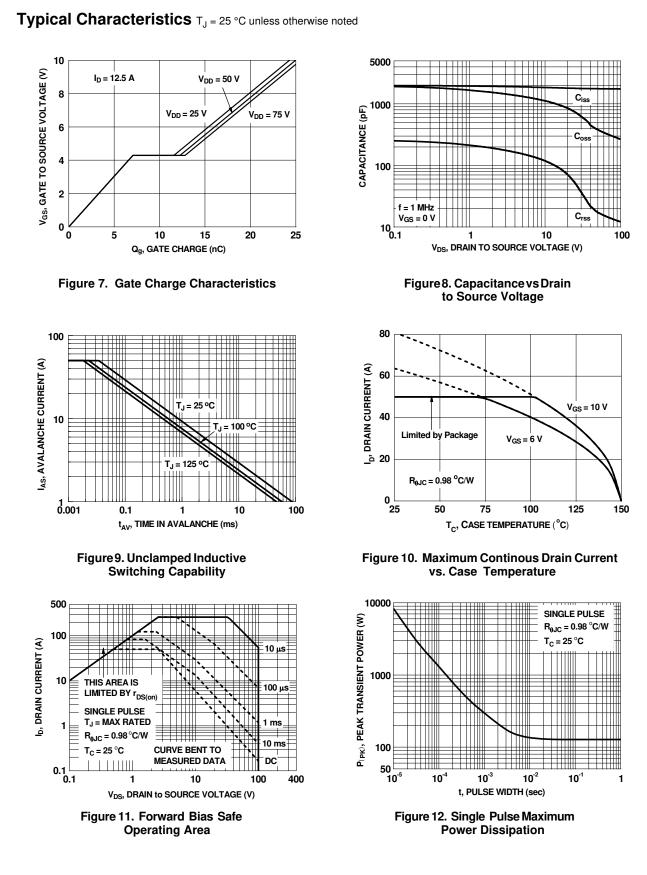
Pulse Test: Pulse Width < 300 µs, Duty cycle < 2.0%.</li>
Starting T<sub>J</sub> = 25 °C, L = 0.3 mH, I<sub>AS</sub> = 30 A, V<sub>DD</sub> = 90 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 48 A.
Pulsed Drain current is tested at 300 µs with 2% duty cycle. For repetitive pulses, the pulse width is limited by the maximum junction temperature.



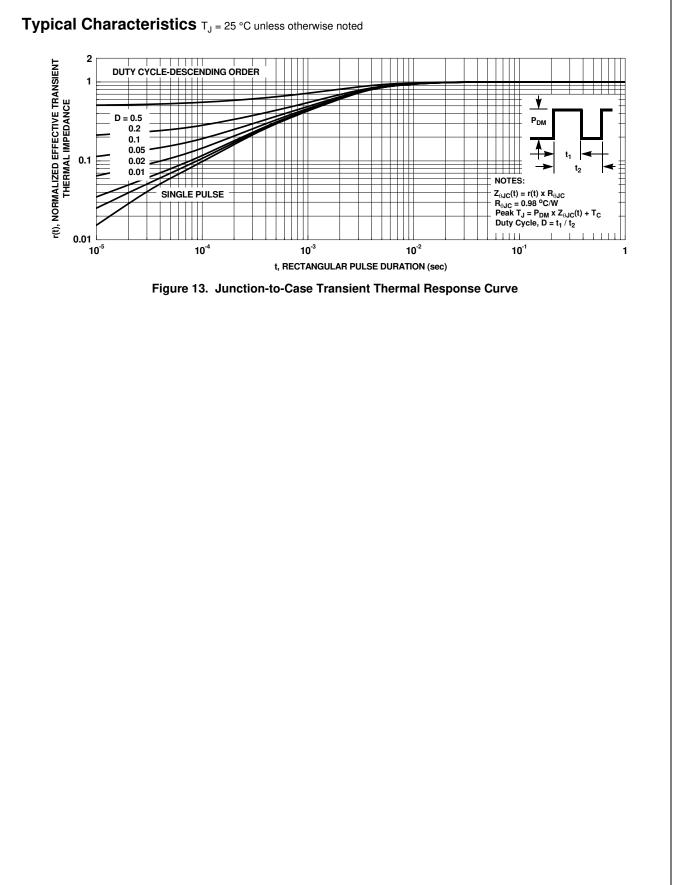


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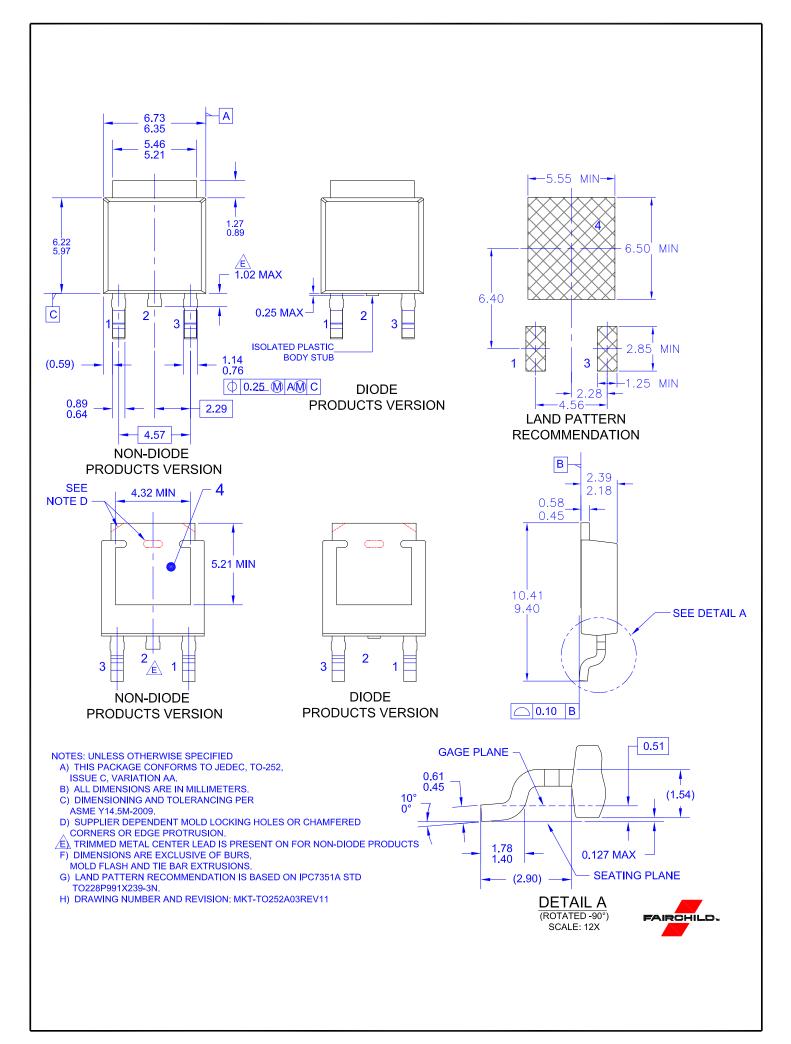
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